

# EMD1S **THRU** EMD4S

## SINGLE-PHASE GLASS PASSIVATED MINI SUPER FAST SURFACE MOUNT BRIDGE RECTIFIER VOLTAGE RANGE 50 to 200 Volts CURRENT 0.5 Ampere

#### **FEATURES**

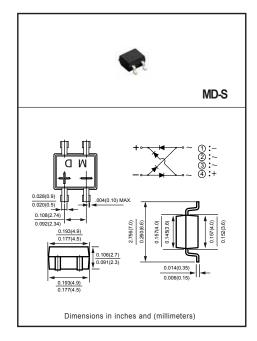
- \* Surge overload rating 20 amperes peak
- \* Ideal for printed circuit board
- \* Reliable low cost construction utilizing molded
- \* Glass passivated device
- $^{\star}$  Polarity symbols molded on body
- \* Mounting position: Any
- \* Weight: 0.5 gram

#### **MECHANICAL DATA**

\* Epoxy: Device has UL flammability classification 94V-O

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25  $^{\circ}\text{C}$  ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.



#### MAXIMUM RATINGS (At T<sub>A</sub> = 25°C unless otherwise noted)

RATINGS	SYMBOL	EMD1S	EMD2S	EMD3S	EMD4S	UNITS
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	150	200	Volts
Maximum RMS Bridge Input Voltage	V <sub>RMS</sub>	35	70	105	140	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	Volts
Maximum Average Forward Output Current at $T_A$ =30°C -on glass-epoxy P.C.B. (Note 2) -on aluminum substrate (Note 3)	Io	0.5 0.8 20			Amps	
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>			Amps		
Typical Junction Capacitance (Note 4)	CJ	15		pF		
Operating and Storage Temperature Range	TJ,TSTG	-55 to + 150			٥C	

#### ELECTRICAL CHARACTERISTICS (At T<sub>A</sub> = 25°C unless otherwise noted)

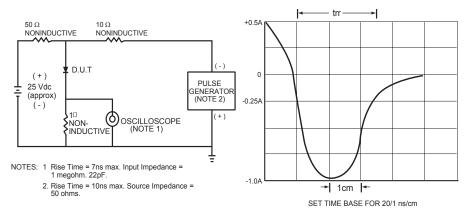
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CHARACTERISTICS	SYMBOL	EMD1S	EMD2S	EMD3S	EMD4S	UNITS	
Maximum Forward Voltage Drop per Bridge		V <sub>F</sub>	1.05				Volts
Element at 0.5A DC							
Maximum Reverse Current at Rated	@T <sub>A</sub> = 25°C	_	10				μAmps
DC Blocking Voltage per element	@T <sub>A</sub> = 125°C	l <sub>R</sub>	0.5				mAmps
Maximum Reverse Recovery Time (Note 5)		trr	50				nS

Note: 1."Fully ROHS compliant","100% Sn plating(Pb-free).

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- 2. On glass-epoxy P.C.B. mounted on 0.05 X 0.05" (1.3 X 1.3mm) pads.
- 3. On aluminum substrate P.C.B. with an area of 0.8 X 0.8 X 0.25" (20 X 20 X 6.4mm) mounted on 0.05 X 0.05" (1.27 X 1.27mm) solder pad. 4. Measure at 1MHz and applied reverse voltage of 4.0 volts.
- 5. Test Condition : I<sub>F</sub>=0.5A, I<sub>R</sub>= -1.0A,I<sub>RR</sub>= -0.25A.

## RATING AND CHARACTERISTICS CURVES (EMD1S THRU EMD4S)



#### FIG.1 TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

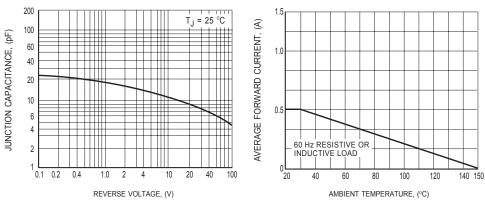
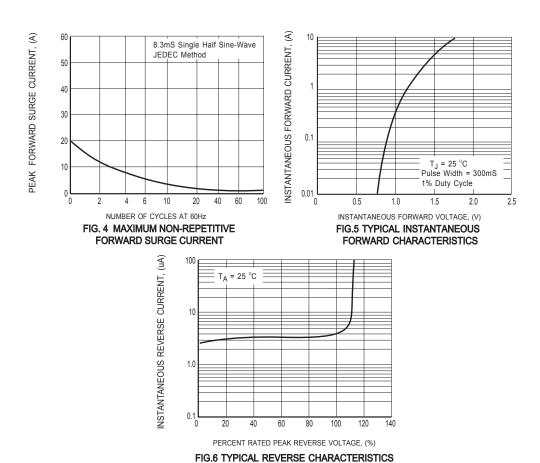


FIG.2 TYPICAL JUNCTION CAPACITANCE

FIG.3 TYPICAL FORWARD CURRENT DERATING CURVE

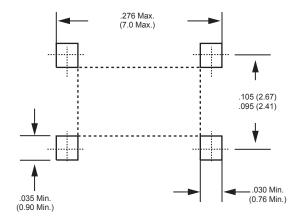


## RATING AND CHARACTERISTICS CURVES (EMD1S THRU EMD4S)





# **Mounting Pad Layout**



Dimensions in inches and (millimeters)



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